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Metallized Polypropylene Film EMI Suppression Capacitors for Harsh Environmental Conditions

R53B, THB Grade IIIB, Class X2, 350 VAC, 125°C (Automotive Grade)

Overview

The R53B series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material that meets the requirements of UL 94 V–0. The R53B series is ideal for harsh environmental conditions and meets the demanding Automotive Electronics Council's AEC–Q200 qualification requirements.

Applications

For worldwide use in electromagnetic interference (EMI) suppression in across-the-line applications that require X2 safety classification. Intended for use in situations in which capacitor failure would not result in exposure to electric shock. Typical applications include connection in series with the mains, capacitive power supplies and energy meters, with special emphasis in automotive applications for severe ambient conditions such as On Board Chargers.

Benefits

- Approvals: ENEC, UL, cUL, CQC
- X2 CLASS (IEC 60384-14)
- THB Grade IIIB: 85°C, 85% RH, 1,000 hours at 350 VAC/800 VDC acc. to IEC 60384-14
- Low Halogen Content according to JS709C
- Rated AC voltage: 350 VAC 50/60 Hz
- Rated DC Voltage: 800 VDC
- Recommended DC Voltage ≤ 1000 VDC
- Capacitance range: 0.068 – 20 µF
- Lead spacing: 15.0 – 52.5 mm
- Capacitance tolerance: ±20%, ±10%
- Climatic category 40/110/56, IEC 60068-1
- Tape & Reel in accordance with IEC 60286-2
- RoHS compliant and lead-free terminations
- Operating temperature range of –40°C to +125°C
- 100% screening factory test at 1,900 VDC
- Self healing properties"
- Automotive (AEC-Q200) grade
- Parallel and Series construction available



Part Number System

R53	B	I	3100	00	0	0	M	C-Spec
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Packaging	Internal Use	Internal Use	Capacitance Tolerance	(Optional)
X2, Metallized Polypropylene	B = 350	I = 15.0 N = 22.5 R = 27.5 W = 37.5 Y = 52.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	0 = Internal Parallel Construction S = Internal Series Construction	0 = Internal Use	K = ±10% M = ±20%	Blank = Standard V103 = 4 pins, S = 37.5 mm, S1 =10.2 mm V104 = 4 pins, S = 37.5 mm, S1 =20.3 mm

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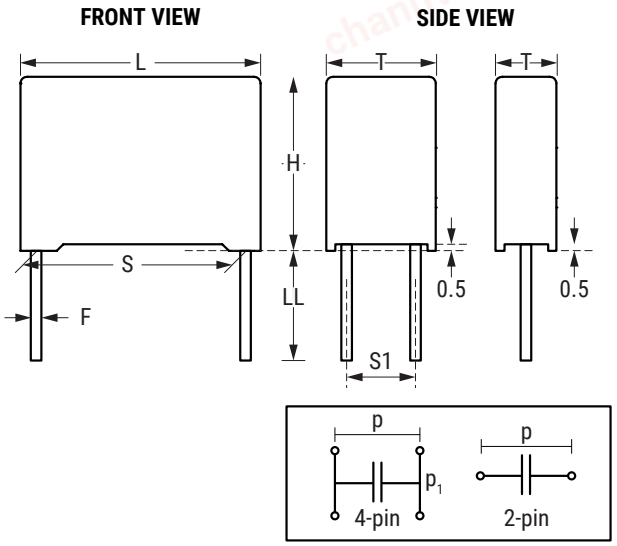
Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
15 22.5	**Standard Lead and Packaging Options**		
	Bulk (Bag) – Short Leads	4 +2/−0	00
	Pizza Pack – Short Leads	4 +2/−0	BB
	Ammo Pack	H_0 = 18.5 ±0.5	DQ[1]
	Other Lead and Packaging Options		
	Tape & Reel (Large Reel)	H_0 = 18.5 ±0.5	CK
	Tape & Reel (Standard Reel)	H_0 = 18.5 ±0.5	GY[1]
	Bulk (Bag)[2]– Short Leads	2.7 +0.5/−0	JA
	Bulk (Bag)[2]– Short Leads	3.5 +0.5/−0	JB
	Bulk (Bag)[2]– Short Leads	4.0 +0.5/−0	JE
	Bulk (Bag)[2]– Short Leads	3.2 +0.3/−0.2	JH
	Bulk (Bag) – Long Leads	18 ±1	JM
	Bulk (Bag) – Long Leads	30 +5/−0	40
	Bulk (Bag) – Long Leads	25 +2/−1	50
27.5	**Standard Lead and Packaging Options**		
	Bulk (Tray) – Short Leads	4 +2/−0	00
	Pizza Pack – Short Leads	4 +2/−0	BB
	Tape & Reel (Large Reel)	H_0= 18.5 ±0.5	CK[1]
	Other Lead and Packaging Options		
	Bulk (Tray) – Short Leads	2.7 +0.5/−0	JA
	Bulk (Tray) – Short Leads	3.5 +0.5/−0	JB
	Bulk (Tray) – Short Leads	4.0 +0.5/−0	JE
	Bulk (Tray) – Short Leads	3.2 +0.3/−0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/−0	40
	Bulk (Tray) – Long Leads	25 +2/−1	50
37.5	**Standard Lead and Packaging Options**		
	Pizza Pack – Short Leads	4 +2/−0	00
	Other Lead and Packaging Options		
	Pizza Pack – Short Leads	2.7 +0.5/−0	JA
	Pizza Pack – Short Leads	3.5 +0.5/−0	JB
	Pizza Pack – Short Leads	4.0 +0.5/−0	JE
	Pizza Pack – Short Leads	3.2 +0.3/−0.2	JH
	Pizza Pack – Long Leads	18 ±1	JM
	Pizza Pack – Long Leads	30 +5/−0	40
	Pizza Pack – Long Leads	25 +2/−1	50
52.5	**Standard Lead and Packaging Options**		
	Pizza Pack – Short Leads	4 +2/−0	00

[1] *Not for all sizes, see "Packaging Quantities" table.*
[2] *For lead spacing 22.5 case sizes ≥8.5*17*26.5 the parts are packed in a Pizza box 335*320*34 mm*

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Dimensions – Millimeters



S		S1		T		H		L		F	
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
15.0	±0.4	-	-	5.0	+0.3/-0.5	11.0	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	-	-	6.0	+0.3/-0.5	12.0	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	-	-	7.5	+0.3/-0.5	13.5	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	-	-	8.5	+0.3/-0.5	14.5	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	-	-	10.0	+0.3/-0.5	16.0	+0.3/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	-	-	11.0	+0.3/-0.5	19.0	+0.3/-0.5	18.0	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	6.0	+0.3/-0.5	15.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	7.0	+0.3/-0.5	16.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	8.5	+0.3/-0.5	17.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	10.0	+0.3/-0.5	18.5	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	11.0	+0.3/-0.5	20.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	13.0	+0.3/-0.5	22.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
27.5	±0.4	-	-	11.0	+0.3/-0.7	20.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	-	-	13.0	+0.3/-0.7	22.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	-	-	13.0	+0.3/-0.7	25.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	-	-	14.0	+0.3/-0.7	28.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	-	-	16.0	+0.3/-0.7	30.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	-	-	22.0	+0.3/-0.7	37.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
37.5	±0.4	10.2(1)	±0.4	20.0	+0.3/-0.7	40.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	10.2(1)	±0.4	24.0	+0.3/-0.7	44.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	20.3(2)	±0.4	30.0	+0.3/-0.7	45.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
52.5	±0.4	20.3(3)	±0.4	30.0	+1.2/-1.2	45.0	+1.2/-1.2	57.5	+1.2/-1.2	1.2	±0.05
52.5	±0.4	20.3(3)	±0.4	35.0	+1.2/-1.2	50.0	+1.2/-1.2	57.5	+1.2/-1.2	1.2	±0.05
Note: See Ordering Options Table for lead length (LL/H_0) options.											

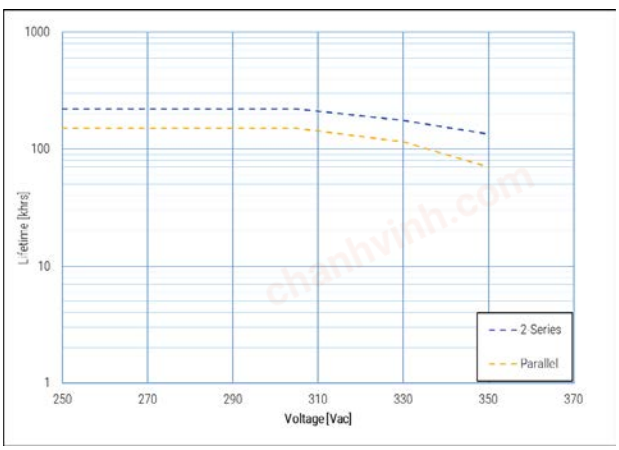
(1) Standard = 2 pins, C-Spec V103 = 4 pins
(2) Standard = 2 pins, C-Spec V104 = 4 pins
(3) Standard = 4 pins, S1 = 20.3mm

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Performance Characteristics

Dielectric	Polypropylene film
Plates	Metal layer deposited by evaporation under vacuum
Winding	Non-inductive type
Leads	Tinned wire
Protection	Plastic case, thermosetting resin filled. Box material is solvent resistant and flame retardant according to UL94.
Related Documents	IEC 60384-14, EN 60384-14
Rated Voltage V_R	350 VAC (50/60 Hz) / 800 VDC
Maximum Operational DC Voltage	≤ 1,000 VDC in parallel construction (1,000 h)
Capacitance Range	0.068 –20 µF
Capacitance Values	E6 series (IEC 60063) measured at 1 kHz and +20 ±1°C
Capacitance Tolerance	±10%, ±20%
Temperature Range	–40°C to 125°C in parallel construction, –40°C to 110°C in series construction
Climatic Category	40/110/56 IEC 60068-1
Reliablity at AC Voltage	

Construction	Temperature(°C)	Voltage (Vac)	Lifetime (khrs) [DeltaC = –20%)
2-Series	85	250	220
2-Series	85	305	220
2-Series	85	330	175
2-Series	85	350	135
Parallel	85	250	150
Parallel	85	305	150
Parallel	85	330	115
Parallel	85	350	70

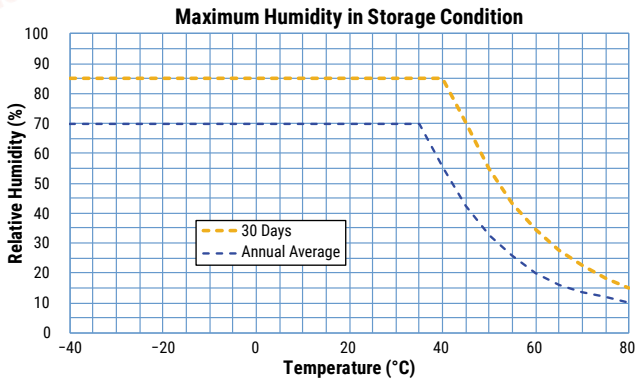


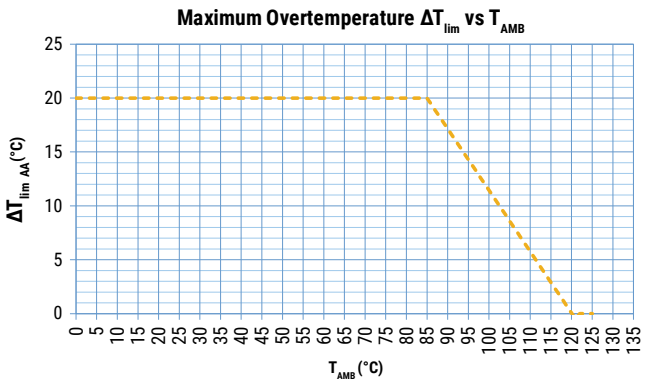
Reliablity at DC Voltage V_R	2,000 hours at 125°C in parallel construction for Pitch 15 to 37.5mm.
Reliablity at DC Voltage V_R	Operation life 100,000 hours at 85°C for all part numbers. 2,000 hours at 125°C in parallel construction for Pitch 15 to 37.5mm.

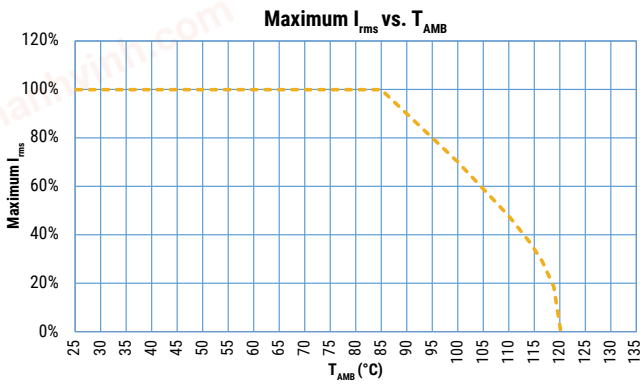
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Performance Characteristics cont.

Storage Conditions	Storage time: ≤ 24 months from the date marked on the label package			
	Average relative humidity per year ≤ 70%			
	RH ≤ 85% for 30 days randomly distributed throughout the year			
	Dew is absent			
	Temperature: −40 to 80°C (see "Maximum Humidity in Storage Conditions" graph below)			
Approvals	ENEC, UL, cUL, CQC			
Dissipation Factor (tanδ) at 1 kHz AT 25°C ±5°C	C ≤ 0.47 µF		C > 0.47 µF	
	0.5%		0.3%	
Test Voltage Between Terminals	The 100% screening factory test is carried out at 1,900 VDC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. This test cannot be repeated, as there is a risk of damaging the capacitor. KEMET is not liable in such cases for any failures.			
Insulation Resistance	Measured at +25°C ±5°C, according to IEC 60384–2			
	Minimum Values Between Terminals			
	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 µF
	100 VDC	1 minute	≥ 30,000 MΩ	≥ 10,000 MΩ • µF







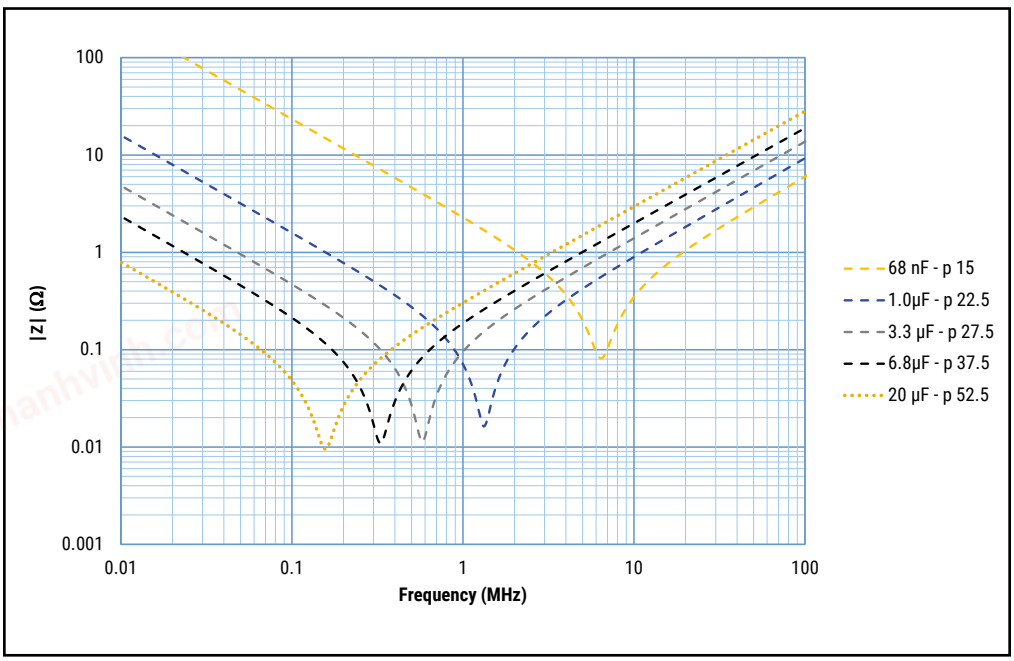
T_{AMB} is the maximum ambient temperature surrounding the capacitor or hottest contact point (e.g. tracks), whichever is higher, in the worst operation conditions in °C.

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Qualification

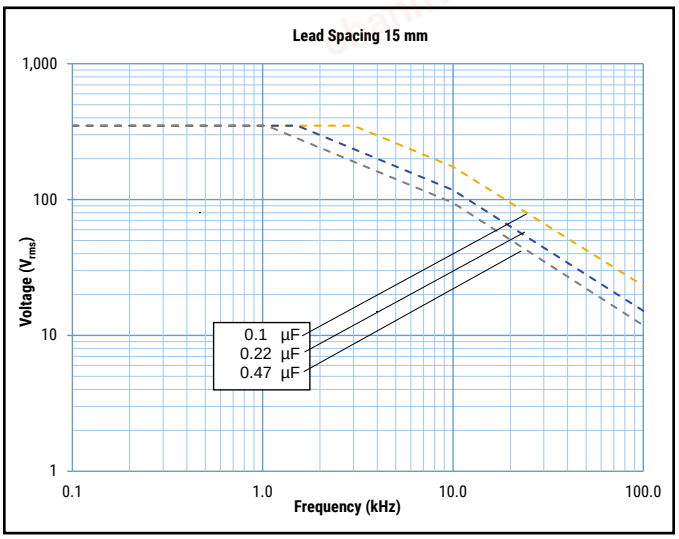
Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit the website at www.aecouncil.com.

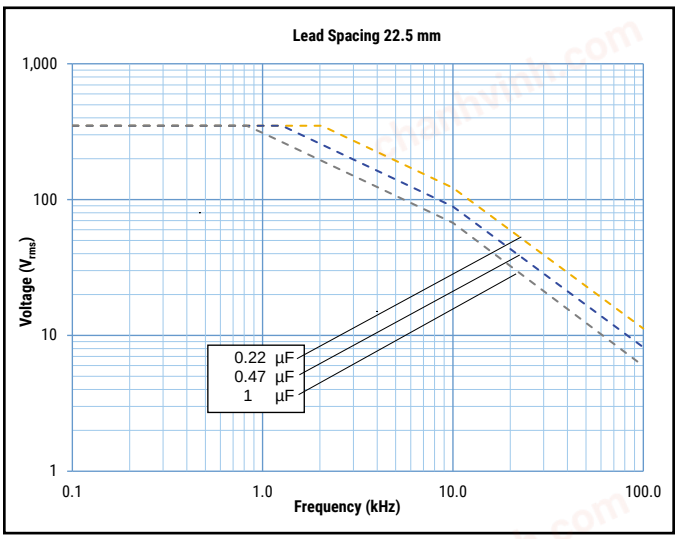
Impedance Graph

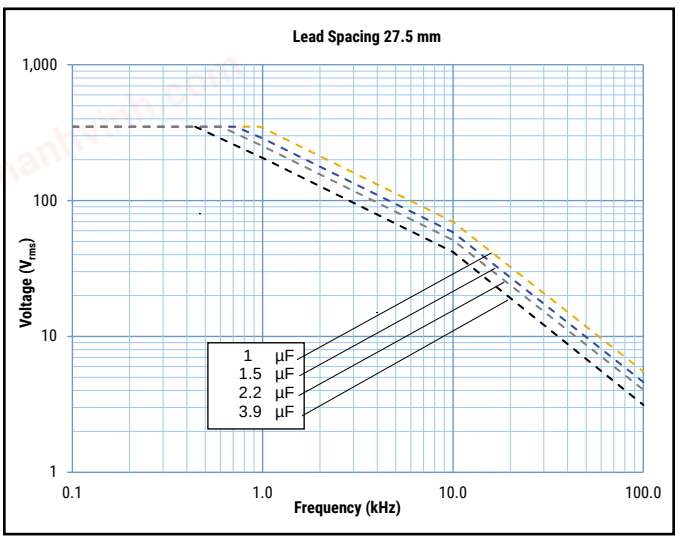


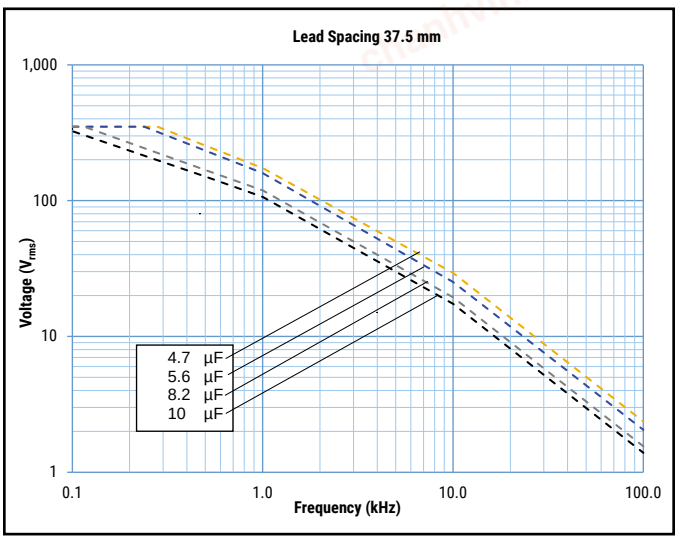
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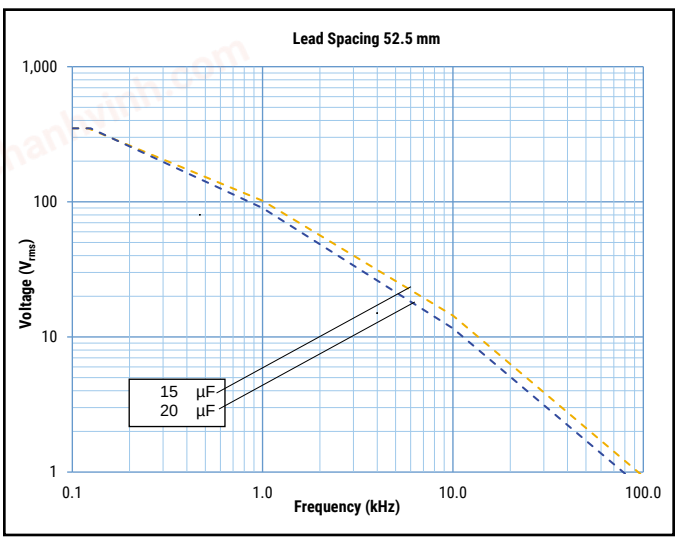
Maximum Voltage (V_{rms}) Versus Frequency (Sinusoidal Waveform/Th ≤ 85°C)





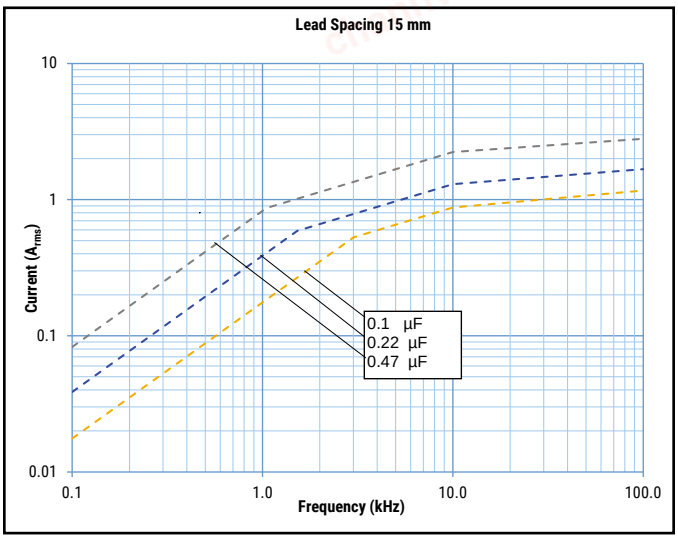


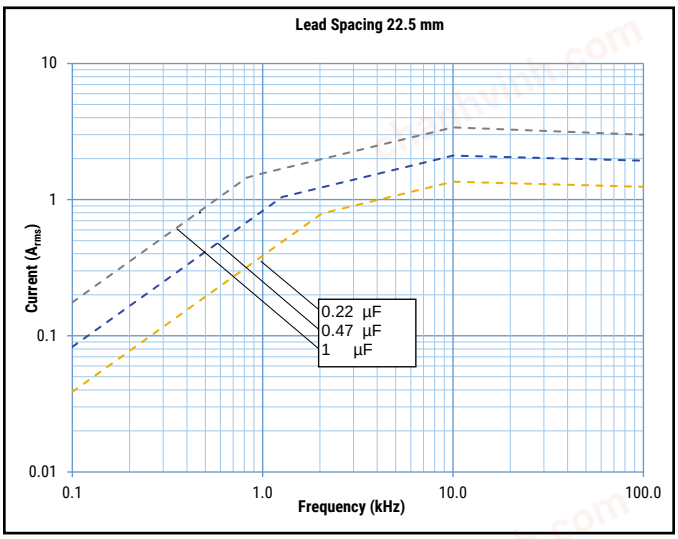


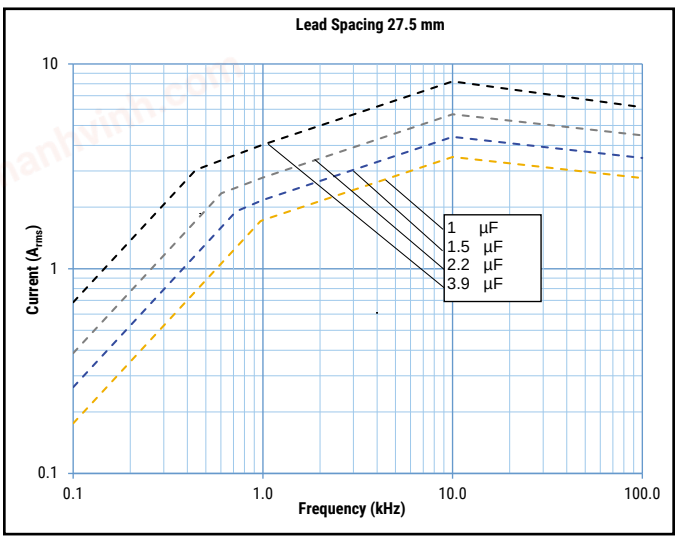


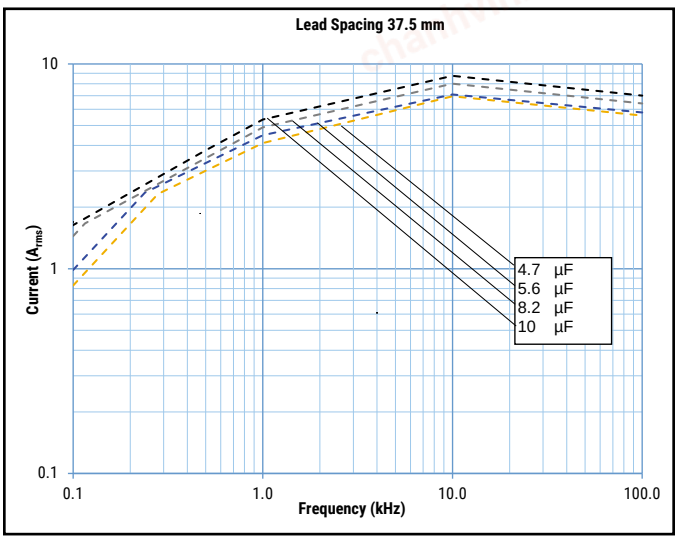
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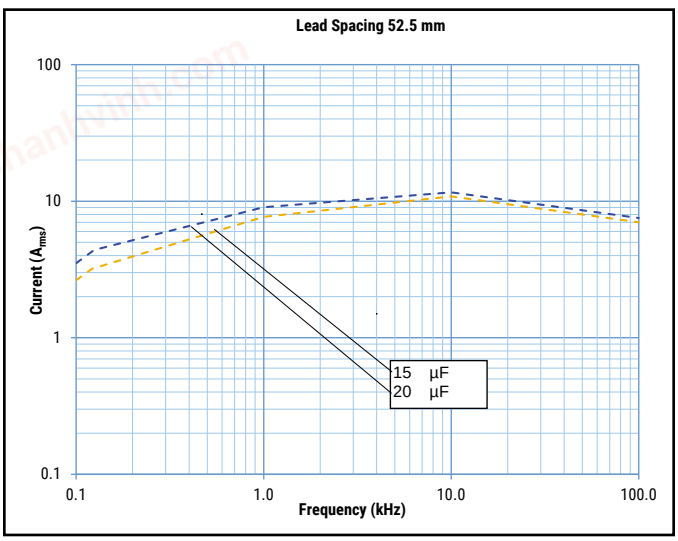
Maximum Current (I_{rms}) Versus Frequency (Sinusoidal Waveform/Th ≤ 85°C)











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Environmental Test Data

Test	IEC Publication	Procedure
Endurance	IEC 60384-14	1.25 x V_R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at rated temperature (110°C)
Endurance	IEC 60384-14	1.25 x V_{RDC}, 1,000 hours at rated temperature (110°C)
Vibration	MIL-STD-202 Method 204	5 G for 20 minutes, 12 cycles each of 3 orientations. Use 8" X 5" PCB, 0.031" thick. 7 secure points on one 8" side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz.
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213. Condition C
Temperature Cycling	JESD22-Method JA-104	1,000 cycles (–40°C to 110°C) Note: Measurement at 24 ±4 hours after test conclusion. 30 minute maximum dwell time at each temperature extreme. 1 minute maximum transition time.
Active Flammability	IEC 60384-14	V_R + 20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384–1, IEC 60695–11–5 Needle flame test
Biased Humidity	According to Grade IIIB (Certification pending) For Parallel and Series construction	85°C/85% RH and 350 VAC, 1,000 hours Capacitance change (ΔC/C): ≤ 10% Dissipation factor change (Δtan δ): ≤ 150 * 10^{-4} (at 1 kHz for Cap > 1 µF) Dissipation factor change (Δtan δ): ≤ 240 * 10^{-4} (at 10 kHz) for Cap ≤ 1 µF IR ≥ 50% of initial limit or minimum 200 MΩ
	According to Grade IIIB (Certification pending) For Parallel construction only	85°C/85% RH and 800 VDC, 1,000 hours Capacitance change (ΔC/C): ≤ 10% Dissipation factor change (Δtan δ): ≤ 150 * 10^{-4} (at 1 kHz for Cap > 1 µF) Dissipation factor change (Δtan δ): ≤ 240 * 10^{-4} (at 10 kHz) for Cap ≤ 1 µF IR ≥ 50% of initial limit or minimum 200 MΩ

Approvals

Certification Body	Mark	Specification	File Number
IMQ S-p.A.		EN/IEC 60384–14	CA08.00236
UL		UL 60384–14 and CAN/CSA E60384–14 (350 VAC)	E97797
CQC		IEC 60384–14	CQC21001325465 CQC21001325444 CQC21001325441 CQC21001325445 CQC21001325440 CQC21001325438

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Environmental Compliance

All KEMET EMI capacitors are RoHS compliant.

Table 1 – Ratings & Part Number Reference for Parts with Internal Parallel Construction

Capacitance Value (µF)	Dimensions in mm			Lead Spacing (S)	dV/dt (V/µs)	KEMET Part Number	Legacy Part Number
	T	H	L				
0.068	5.0	11.0	18.0	15	400	53BI2680(1)00(2)	R53BI2680(1)00(2)
0.1	6.0	12.0	18.0	15	400	53BI3100(1)00(2)	R53BI3100(1)00(2)
0.15	7.5	13.5	18.0	15	400	53BI3150(1)00(2)	R53BI3150(1)00(2)
0.22	8.5	14.5	18.0	15	400	53BI3220(1)00(2)	R53BI3220(1)00(2)
0.33	10.0	16.0	18.0	15	400	53BI3330(1)00(2)	R53BI3330(1)00(2)
0.39	11.0	19.0	18.0	15	400	53BI3390(1)00(2)	R53BI3390(1)00(2)
0.47	11.0	19.0	18.0	15	400	53BI3470(1)00(2)	R53BI3470(1)00(2)
0.22	6.0	15.0	26.5	22.5	200	53BN3220(1)00(2)	R53BN3220(1)00(2)
0.33	7.0	16.0	26.5	22.5	200	53BN3330(1)00(2)	R53BN3330(1)00(2)
0.47	8.5	17.0	26.5	22.5	200	53BN3470(1)00(2)	R53BN3470(1)00(2)
0.56	10.0	18.5	26.5	22.5	200	53BN3560(1)00(2)	R53BN3560(1)00(2)
0.68	11.0	20.0	26.5	22.5	200	53BN3680(1)00(2)	R53BN3680(1)00(2)
1	13.0	22.0	26.5	22.5	200	53BN4100(1)00(2)	R53BN4100(1)00(2)
0.82	11.0	20.0	32.0	27.5	150	53BR3820(1)00(2)	R53BR3820(1)00(2)
1	13.0	22.0	32.0	27.5	150	53BR4100(1)00(2)	R53BR4100(1)00(2)
1.2	13.0	22.0	32.0	27.5	150	53BR4120(1)00(2)	R53BR4120(1)00(2)
1.5	13.0	25.0	32.0	27.5	150	53BR4150(1)00(2)	R53BR4150(1)00(2)
1.8	14.0	28.0	32.0	27.5	150	53BR4180(1)00(2)	R53BR4180(1)00(2)
2.2	16.0	30.0	32.0	27.5	150	53BR4220(1)00(2)	R53BR4220(1)00(2)
3.3	22.0	37.0	32.0	27.5	150	53BR4330(1)00(2)	R53BR4330(1)00(2)
3.9	22.0	37.0	32.0	27.5	150	53BR4390(1)00(2)	R53BR4390(1)00(2)
4.7	20.0	40.0	42.0	37.5	100	53BW4470(1)00(2)	R53BW4470(1)00(2)
5.6	20.0	40.0	42.0	37.5	100	53BW4560(1)00(2)	R53BW4560(1)00(2)
6.8	24.0	44.0	42.0	37.5	100	53BW4680(1)00(2)	R53BW4680(1)00(2)
8.2	24.0	44.0	42.0	37.5	100	53BW4820(1)00(2)	R53BW4820(1)00(2)
10	30.0	45.0	42.0	37.5	100	53BW5100(1)00(2)	R53BW5100(1)00(2)
15	30.0	45.0	57.5	52.5	50	53BY5150(1)00(2)	R53BY5150(1)00(2)
18	35.0	50.0	57.5	52.5	50	53BY5180(1)00(2)	R53BY5180(1)00(2)
20	35.0	50.0	57.5	52.5	50	53BY5200(1)00(2)	R53BY5200(1)00(2)
Capacitance Value (µF)	**T (mm)**	**H (mm)**	**L (mm)**	**Lead Spacing (S)**	**dV/dt (V/µs)**	**KEMET Part Number**	**Legacy Part Number**

(1) Insert lead and packaging code. See Ordering Options Table for available options.
(2) M = ±20%, K = ±10%

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Table 2 – Ratings & Part Number Reference for Parts with Internal Series Construction

Capacitance Value (µF)	Dimensions in mm			Lead Spacing (S)	dV/dt (V/µs)	KEMET Part Number	Legacy Part Number
	T	H	L				
0.068	5.0	11.0	18.0	15	400	53BI2680(1)S0M	R53BI2680(1)S0M
0.1	6.0	12.0	18.0	15	400	53BI3100(1)S0M	R53BI3100(1)S0M
0.15	7.5	13.5	18.0	15	400	53BI3150(1)S0M	R53BI3150(1)S0M
0.22	8.5	14.5	18.0	15	400	53BI3220(1)S0M	R53BI3220(1)S0M
0.33	10.0	16.0	18.0	15	400	53BI3330(1)S0M	R53BI3330(1)S0M
0.39	11.0	19.0	18.0	15	400	53BI3390(1)S0M	R53BI3390(1)S0M
0.47	11.0	19.0	18.0	15	400	53BI3470(1)S0M	R53BI3470(1)S0M
0.22	6.0	15.0	26.5	22.5	200	53BN3220(1)S0M	R53BN3220(1)S0M
0.33	7.0	16.0	26.5	22.5	200	53BN3330(1)S0M	R53BN3330(1)S0M
0.47	8.5	17.0	26.5	22.5	200	53BN3470(1)S0M	R53BN3470(1)S0M
0.56	10.0	18.5	26.5	22.5	200	53BN3560(1)S0M	R53BN3560(1)S0M
0.68	11.0	20.0	26.5	22.5	200	53BN3680(1)S0M	R53BN3680(1)S0M
1	13.0	22.0	26.5	22.5	200	53BN4100(1)S0M	R53BN4100(1)S0M
0.82	11.0	20.0	32.0	27.5	150	53BR3820(1)S0M	R53BR3820(1)S0M
1	13.0	22.0	32.0	27.5	150	53BR4100(1)S0M	R53BR4100(1)S0M
1.2	13.0	22.0	32.0	27.5	150	53BR4120(1)S0M	R53BR4120(1)S0M
1.5	13.0	25.0	32.0	27.5	150	53BR4150(1)S0M	R53BR4150(1)S0M
1.8	14.0	28.0	32.0	27.5	150	53BR4180(1)S0M	R53BR4180(1)S0M
2.2	16.0	30.0	32.0	27.5	150	53BR4220(1)S0M	R53BR4220(1)S0M
3.3	22.0	37.0	32.0	27.5	150	53BR4330(1)S0M	R53BR4330(1)S0M
3.9	22.0	37.0	32.0	27.5	150	53BR4390(1)S0M	R53BR4390(1)S0M
4.7	20.0	40.0	42.0	37.5	100	53BW4470(1)S0M	R53BW4470(1)S0M
5.6	20.0	40.0	42.0	37.5	100	53BW4560(1)S0M	R53BW4560(1)S0M
6.8	24.0	44.0	42.0	37.5	100	53BW4680(1)S0M	R53BW4680(1)S0M
8.2	24.0	44.0	42.0	37.5	100	53BW4820(1)S0M	R53BW4820(1)S0M
10	30.0	45.0	42.0	37.5	100	53BW5100(1)S0M	R53BW5100(1)S0M
15	30.0	45.0	57.5	52.5	50	53BY5150(1)S0M	R53BY5150(1)S0M
18	35.0	50.0	57.5	52.5	50	53BY5180(1)S0M	R53BY5180(1)S0M
20	35.0	50.0	57.5	52.5	50	53BY5200(1)S0M	R53BY5200(1)S0M
Capacitance Value (µF)	**T (mm)**	**H (mm)**	**L (mm)**	**Lead Spacing (S)**	**dV/dt (V/µs)**	**KEMET Part Number**	**Legacy Part Number**

(1) Insert lead and packaging code. See table for available options.

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Soldering Process

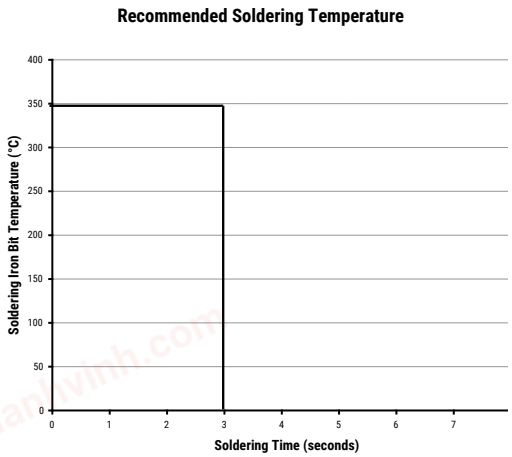
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder material. This has increased the liquidus temperature from 183°C for SnPb eutectic alloys to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 – 15 mm). Great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above-recommended limits may result to degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after curing surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal temperature before performing the second soldering cycle.

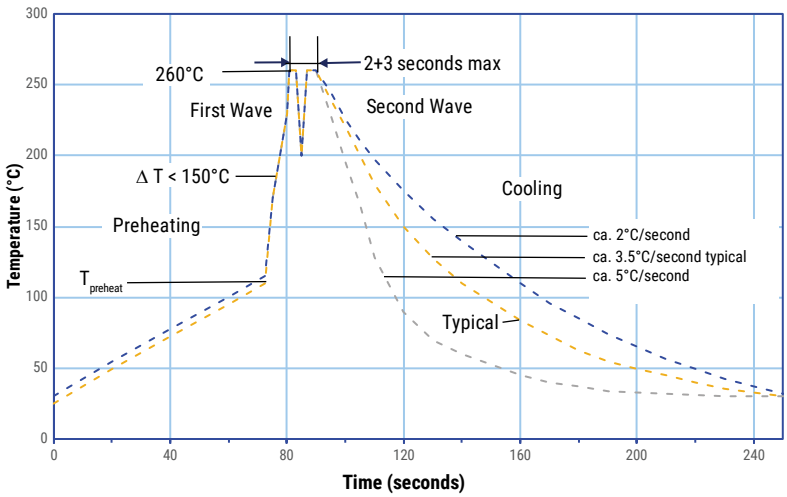
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations



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Soldering Process cont.

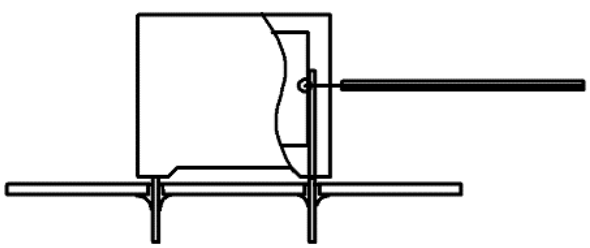
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process.

Dielectric Film Material	Maximum Preheat Temperature		Maximum Peak Soldering Temperature	
	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	270°C	270°C
Polypropylene	125°C	130°C	260°C	270°C
Paper	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor: set the temperature so that the maximum temperature inside the element is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	125°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as it is in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 – 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts do not overheat.

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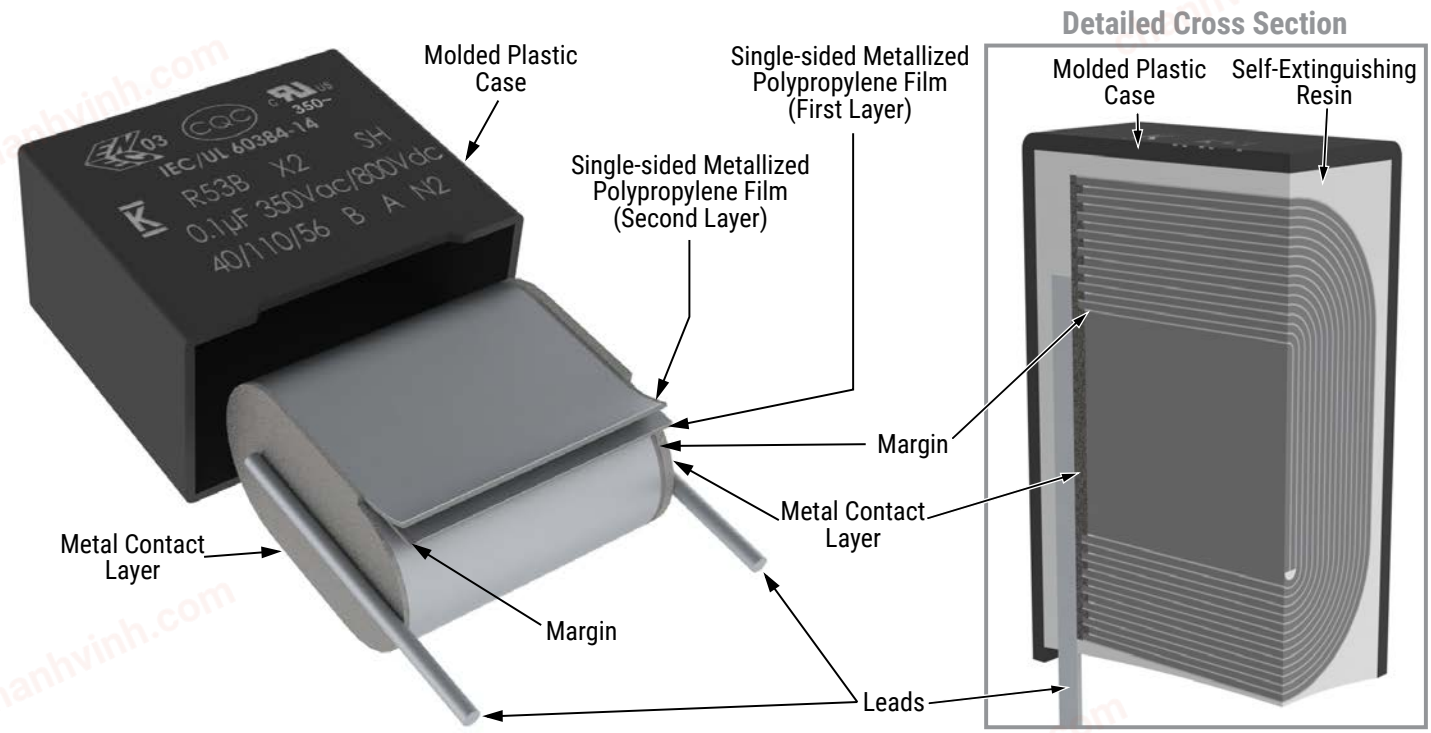
Mounting

Resistance to Vibration and Mechanical Shock

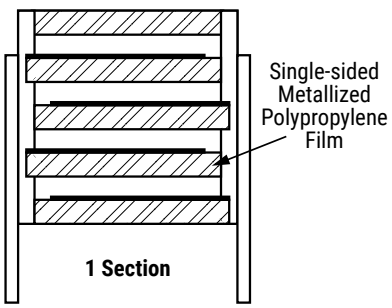
AEC-Q200 Mechanical Stress Tests:		
Mechanical Shock	MIL-SDT-202 Method 213	Test condition C Peak value 100 g, duration 6 ms, half-sine-wave (see MIL-HDBK for details)
Vibration	MIL-SDT-202 Method 204	5 G for 20 minutes, 12 cycles each of 3 orientations Use 8"X5" PCB, 0.031" thick. 7 secure points on one 8" side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz.

The capacitors are designed for PCB mounting.
The stand-off pipes must be in good contact with the printed circuit board.
The capacitor body has to be properly fixed (e.g. clamped or glued).

Construction

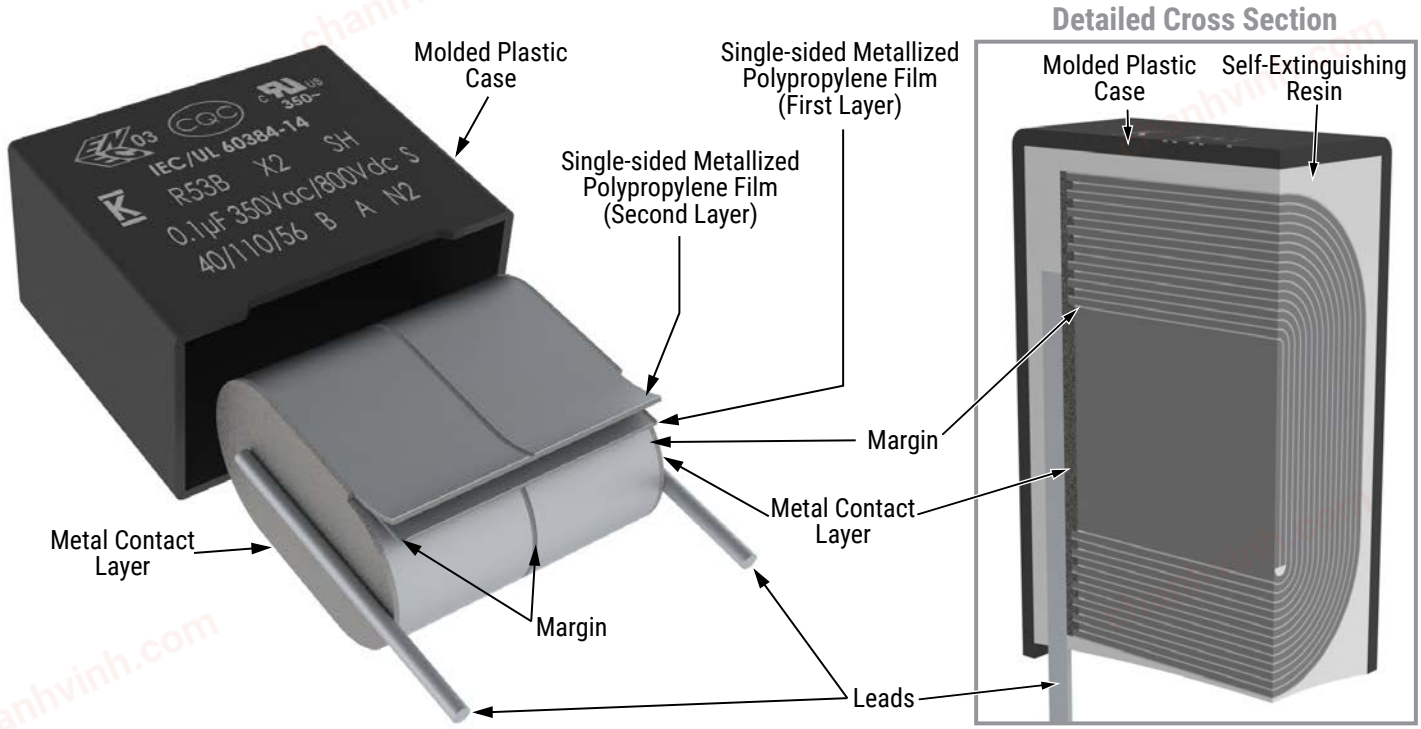


Winding Scheme

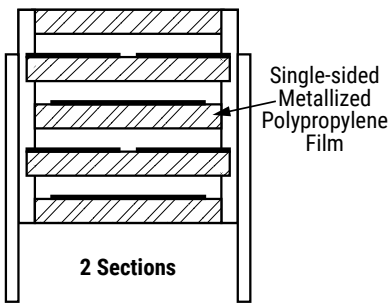


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Construction cont.



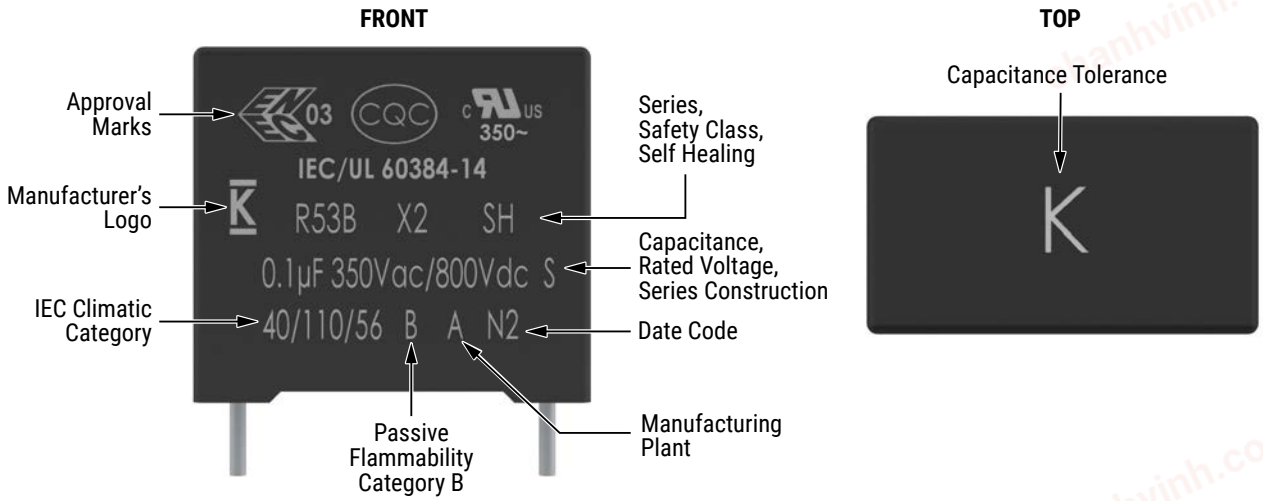
Winding Scheme



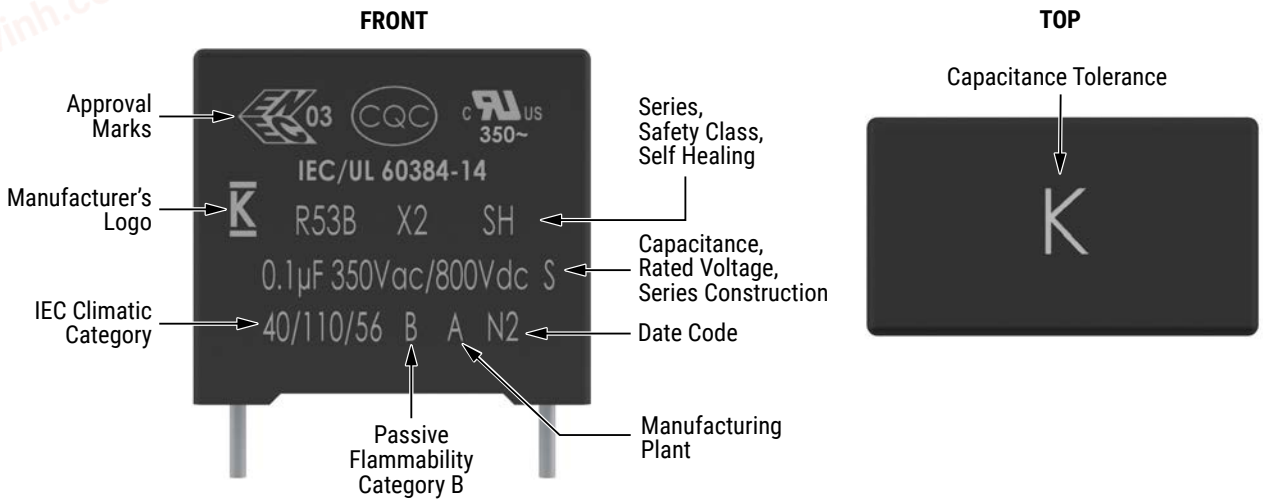
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Marking

Parallel Construction Part Numbers: Lead Spacing 15 mm, 22.5 mm, and 27.5 mm



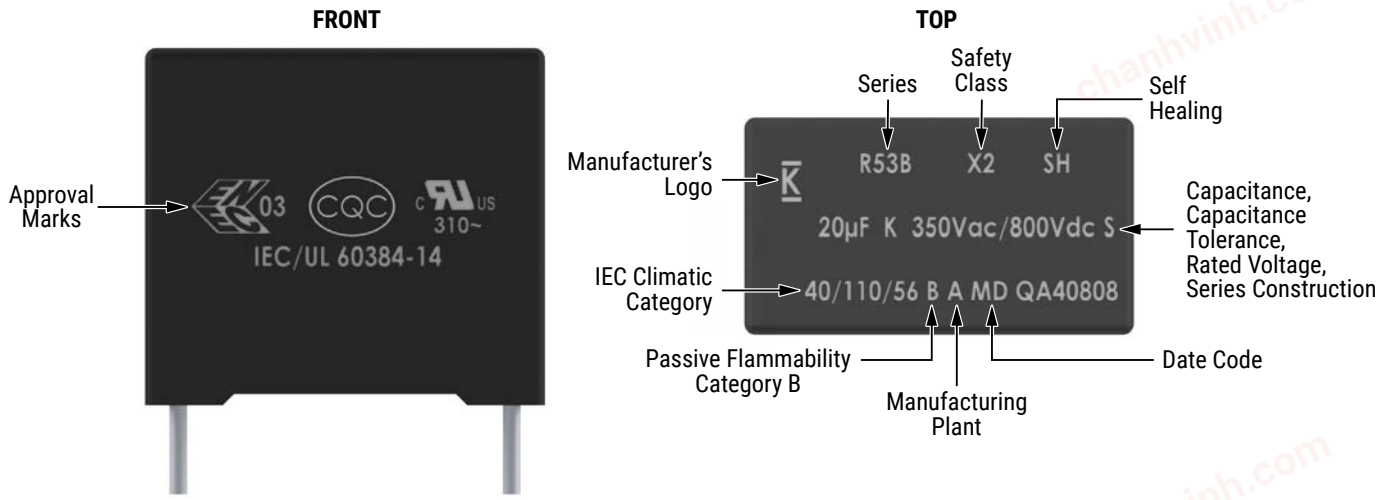
Series Construction Part Numbers: Lead Spacing 15 mm, 22.5 mm, and 27.5 mm



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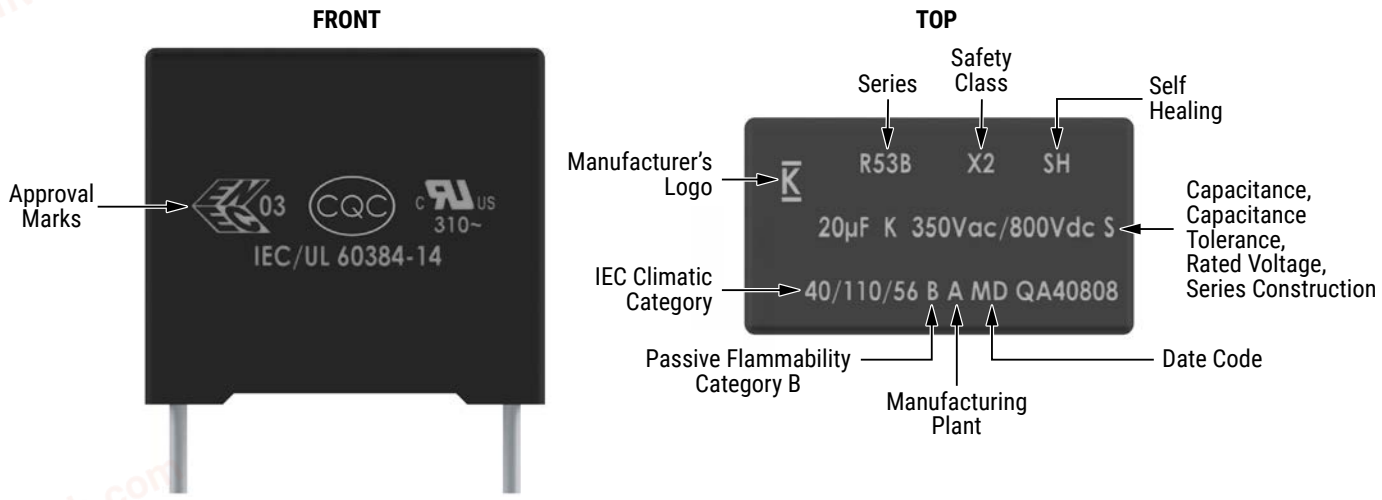
Marking cont.

Parallel Construction Part Numbers: Lead Spacing 27.5 mm (alternatives*), 37.5 mm and 52.5 mm



*Differences are caused by technology (clichee, laser, or ink) and production line.

Series Construction Part Numbers: Lead Spacing 27.5 mm (alternatives*), 37.5 mm and 52.5 mm



*Differences are caused by technology (clichee, laser, or ink) and production line.

Manufacturing Date Code (IEC–60062)

Year	Code	Year	Code	Month	Code	Month	Code
2020	M	2030	A	January	1	July	7
2021	N	2031	B	February	2	August	8
2022	P	2032	C	March	3	September	9
2023	R	2033	D	April	4	October	O
2024	S	2034	E	May	5	November	N
2025	T	2035	F	June	6	December	D
2026	U	2036	H				
2027	V	2037	J				
2028	W	2038	K				
2029	X	2039	L				

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Packaging Quantities

Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads		Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped	Pizza
Lead and Packaging Code:				**00 - JA - JB JE - JH**	**JM**	**40 – 50**	**GY**	**CK**	**DQ**	**BB**
15	5	11	18	2,000	1,250	1,000	600	1,250	800	1,122
	6	12	18	1,750	1,000	900	500	1,000	680	935
	7.5	13.5	18	1,000	800	700	350	800	500	748
	8.5	14.5	18	1,000	650	500	300	700	440	663
	10	16	18	750	550	500	270	600	380	561
	11	19	18	450	400	350	-	500	340	510
22.5	6	15	26.5	805	450	500	-	700	464	660
	7	16	26.5	700	450	500	-	550	380	564
	8.5	17	26.5	468	350	300	-	450	280	468
	10	18.5	26.5	396	350	300	-	350	235	396
	11	20	26.5	360	200	250	-	350	217	360
	13	22	26.5	300	150	200	-	300	-	300
27.5	11	20	32	560	336	336	-	350	-	300
	13	22	32	480	288	288	-	300	-	250
	13	25	32	480	288	288	-	-	-	250
	14	28	32	352	176	176	-	-	-	230
	16	30	32	288	144	144	-	-	-	200
	22	37	32	168	112	112	-	-	-	150
37.5	20	40	42	-	-	-	-	-	-	58
	24	44	42	-	-	-	-	-	-	44
	30	45	42	-	-	-	-	-	-	36
52.5	30	45	57.5	-	-	-	-	-	-	27
	35	50	57.5	-	-	-	-	-	-	23

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Lead Taping & Packaging (IEC 60286–2)

Figure 1 – Lead Spacing 15 mm

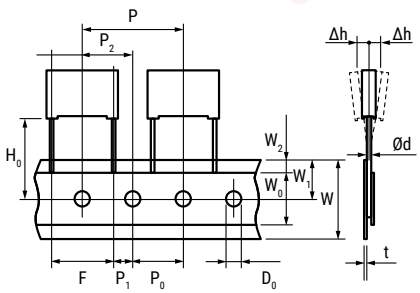
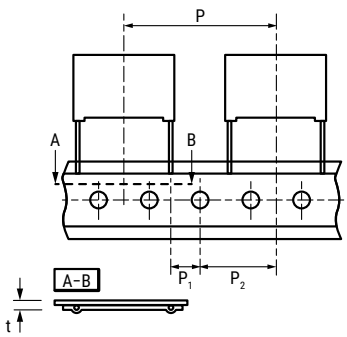


Figure 2 – Lead Spacing 22.5 & 27.5 mm



Taping Specification

Description	Symbol	Dimensions (mm)			
		Lead Space			Tolerance
		15.0	22.5	27.5	
Lead wire diameter	d	0.6 – 0.8	0.8	0.8	±0.05
Taping lead space	P	25.4	38.1	38.1	±1
Feed hole lead space *	P_0	12.7	12.7	12.7	±0.2 **
Centering of the lead wire	P_1	5.2	7.8	5.3	±0.7
Centering of the body	P_2	12.7	19.05	19.05	±1.3
Lead spacing ***	F	15.0	22.5	27.5	+0.6/−0.1
Component alignment	Δh	0	0	0	±2
Component deviation	Δp	0	0	0	±1
Height of component from tape center	H_0****	18.5	18.5	18.5	±0.5
Carrier tape width	W	18	18	18	+1/−0.5
Hold down tape width	W_0	10	10	10	Minimum
Hole position	W_1	9	9	9	±0.5
Hold down tape position	W_2	3	3	3	Maximum
Feed hole diameter	D_0	4	4	4	±0.2
Total Tape thickness	t	0.7	0.7	0.7	±0.2

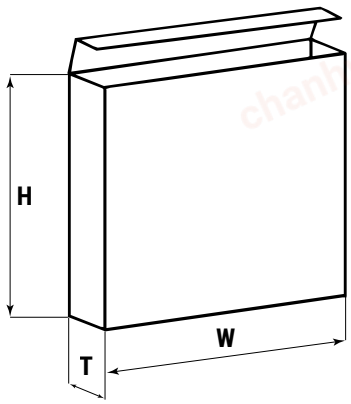
** Available also 15 mm.*
*** Maximum 1 mm on 20 lead spacing.*
**** 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request.*
***** H_0 = 16.5 mm is available upon request.*

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Lead Taping & Packaging (IEC 60286–2) cont.

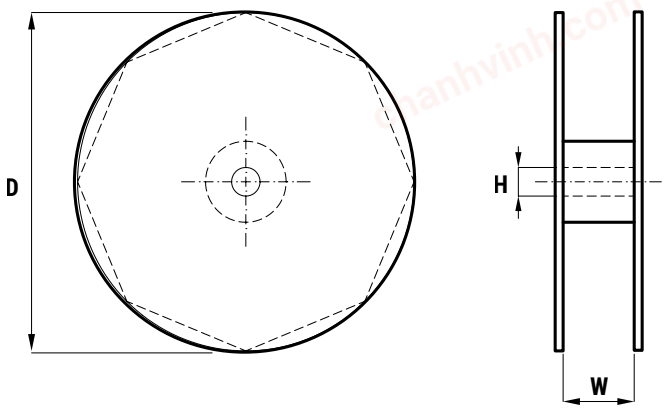
Ammo Specifications

Dimensions (mm)		
H	W	T
360	340	59



Reel Specifications

Reel Size	Dimensions (mm)		
	D	H	W
Standard	355	30	55 Maximum
Large	500	25	



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